

Data and signal line chokes

SIMDAD 1812, common-mode chokes 42 V AC/80 V DC, 11 ... 100 μ H, 150 ... 300 mA

 Series/Type:
 B82789C0/S0

 Date:
 June 2016

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Rated voltage 42 V AC/80 V DC Rated inductance 11 ... 100 μH Rated current 150 ... 300 mA

Construction

- Current-compensated double choke
- Ferrite I core
- Winding: enamel copper wire
- Winding welded to terminals
- Bifilar winding (B82789C0...)
- Sector winding (B82789S0...)

Features

- Temperature range up to +150 °C (B82789C0/S0*H)
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020D
- For gold-plated terminals conductive adhesion possible
- Qualified to AEC-Q200
- RoHS-compatible

Function

■ B82789C0:

Suppression of asymmetrical interference coupled in on lines, whereas data signals up to some MHz can pass unaffectedly.

■ B82789S0:

Suppression of asymmetrical (by L_R) and symmetrical interference (by L_{stray}) coupled in on lines. The high-frequency portions of the symmetrical data signal are decreased so far that EMC problems can be significantly reduced.

Applications

- Automotive applications, e.g. CAN and FlexRay bus
- Industrial field bus systems
- Line cards for telecom

Terminals

Tinned terminals (B82789C0/S0*002)

- Base material CuSn6
- Layer composition Ni, Ag, Sn¹⁾
- Lead-free tinned

Gold-plated terminals (B82789C0/S0*001)

- Base material CuSn6
- Layer composition Ni, Ag, Au
- Gold plated



Please read *Cautions and warnings* and *Important notes* at the end of this document.



¹⁾ Ni-barrier-plated terminals (NiSn) on request (B82789C0/S0*H052).



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Marking

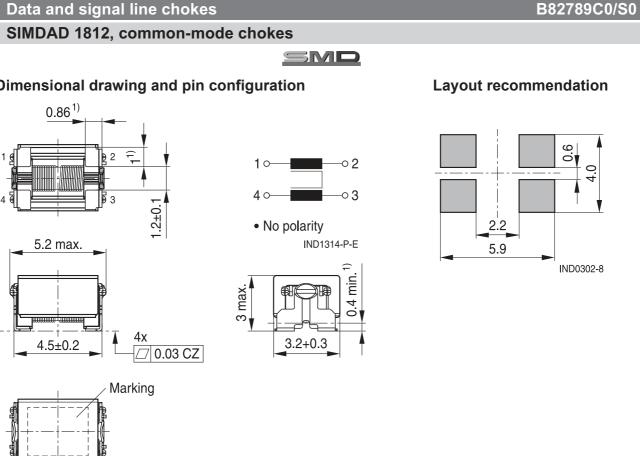
- Marking on component: Manufacturer, bifilar or sector winding (coded), L value (in nH; for version B82789C0/S0*H052 underlined), date of manufacture (YWWD), two last digits of production order
- Minimum data on reel: Manufacturer, ordering code, L value (in nH), quantity, date of packing

Delivery mode and packing unit

- 12-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 2500 pcs./reel

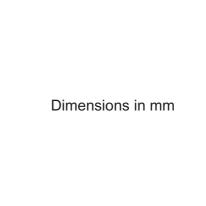
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IND1305-G-E

Layout recommendation

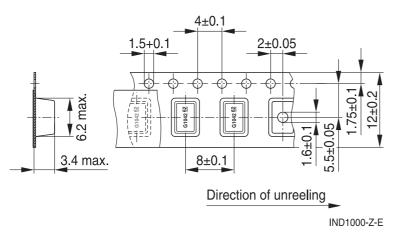


Reel

Taping and packing

Blister tape

¹⁾ Soldering area



 $13^{+0.5}_{-0.2}$ 18.4 max. ø330±2 12.4^{+2}_{-0} 100±1 IND0421-C

Dimensions in mm

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Dimensional drawing and pin configuration



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Technical data and measuring conditions

Rated voltage V _R	42 V AC (50/60 Hz) / 80 V DC			
Test voltage V _{test}	250 V DC, 2 s (line/line)			
Rated temperature T _R	+85 °C / +110 °C			
Rated current I _R	Referred to 50 Hz and rated temperature			
Rated inductance L _R	Measured with Agilent 4284A at 100 kHz, 0.1 mA, +20 °C Inductance is specified per winding.			
Inductance tolerance	–30/+50% at +20 °C			
Inductance decrease $\Delta L/L_0$	Common mode < 10% at DC magnetic bias with I _R , +20 °C			
Stray inductance L _{stray,typ}	Measured with Agilent 4284A at 100 kHz, 5 mA, +20 °C, typical values			
DC resistance R _{max}	Measured at +20 °C, specified per winding			
Solderability (lead-free)	Dip and look method Sn95.5Ag3.8Cu0.7: +(245 \pm 5) °C, (3 \pm 0.3) s Wetting of soldering area \geq 90% (based on IEC 60068-2-58)			
Resistance to soldering heat	+260 °C, 40 s as referenced in JEDEC J-STD 020D			
Climatic category	55/125/56 (B82789*N) 55/150/56 (B82789*H) (to IEC 60068-1)			
Storage conditions	Mounted: -55 °C +125 °C (B82789C0/S0*N) -55 °C +150 °C (B82789C0/S0*H) Packaged: -25 °C +40 °C, ≤ 75% RH			
Weight Approx. 0.16 g				

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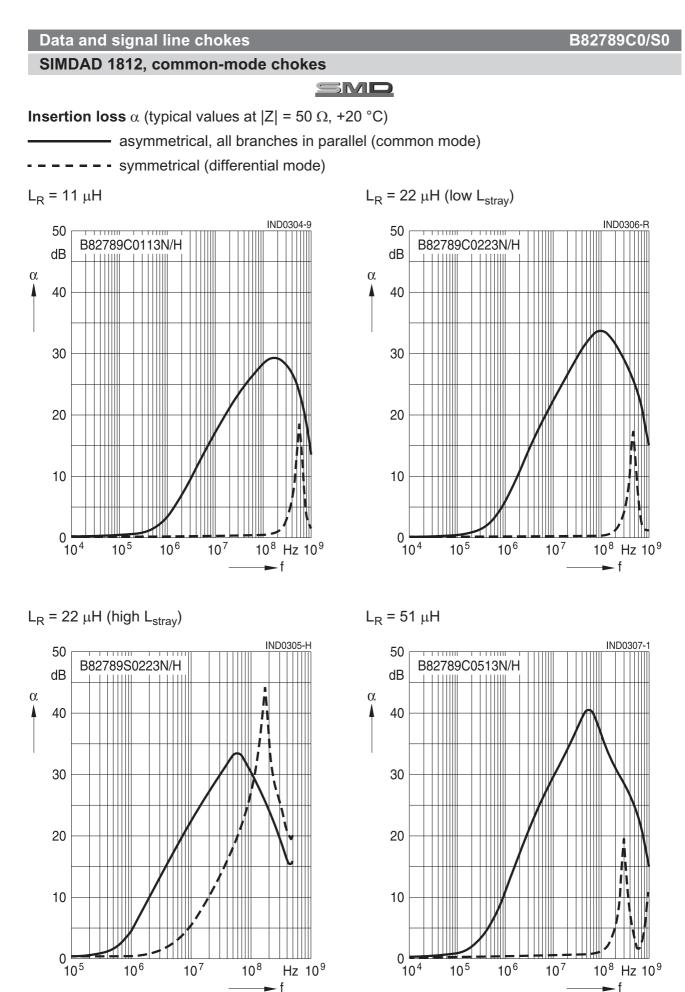
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Characteristics and ordering codes

L _R	L _{stray,typ}	I _R	R _{max}	Τ _R	Ordering code		
μH	μН	mA	mΩ	°C	Gold-plated terminals	Tinned terminals	
B82789C0/S0*N (operating temperature: -55 +125 °C)							
11	0.06	300	250	85	B82789C0113N001	B82789C0113N002	
22	0.10	250	580	85	B82789C0223N001	B82789C0223N002	
22	3.0	250	580	85	B82789S0223N001	B82789S0223N002	
51	0.10	250	550	85	B82789C0513N001	B82789C0513N002	
100	0.25	150	1500	85	B82789C0104N001	B82789C0104N002	
B82789C0/S0*H (operating temperature: -55 +150 °C)							
11	0.06	300	250	110	B82789C0113H001	B82789C0113H002 ¹⁾	
22	0.10	250	580	110	B82789C0223H001	B82789C0223H0021)	
22	3.0	250	580	110	B82789S0223H001	B82789S0223H0021)	
51	0.10	250	550	110	B82789C0513H001	B82789C0513H0021)	
100	0.25	150	1500	110	B82789C0104H001	B82789C0104H0021)	

¹⁾ Replace the two last digits "02" by "52" for Ni-barrier-plated terminals.

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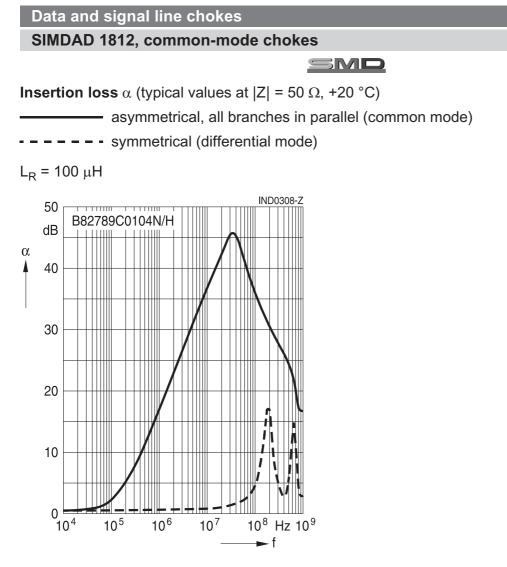


Please read *Cautions and warnings* and *Important notes* at the end of this document.

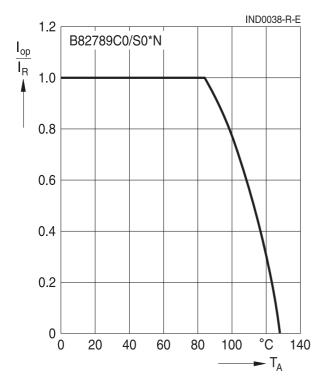
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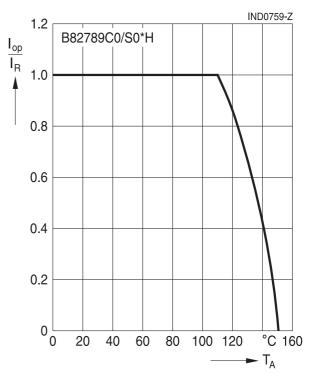




Current derating $\mathbf{I}_{op}/\mathbf{I}_{R}$ versus ambient **temperature** (rated temperature T_R = +85 °C)







Please read Cautions and warnings and Important notes at the end of this document.

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Cautions and warnings



- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.

Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.

- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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